



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

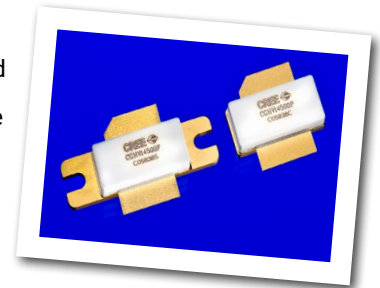
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



CGHV14500

500 W, 1200 - 1400 MHz, GaN HEMT for L-Band Radar Systems

Cree's CGHV14500 is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically with high efficiency, high gain and wide bandwidth capabilities, which makes the CGHV14500 ideal for 1.2 - 1.4 GHz L-Band radar amplifier applications. The transistor could be utilized for band specific applications ranging from 800 through 1600 MHz. The package options are ceramic/metal flange and pill package.



Package Type: 440117, 440133
PN: CGHV14500

Typical Performance Over 1.2-1.4 GHz ($T_c = 25^\circ\text{C}$) of Demonstration Amplifier

Parameter	1.2 GHz	1.25 GHz	1.3 GHz	1.35 GHz	1.4 GHz	Units
Output Power	545	540	530	530	530	W
Gain	16.4	16.3	16.2	16.2	16.2	dB
Drain Efficiency	69	69	68	66	65	%

Note:

Measured in the CGHV14500-AMP amplifier circuit, under 500 μs pulse width, 10% duty cycle, $P_{IN} = 41 \text{ dBm}$.

Features

- Reference design amplifier 1.2 - 1.4 GHz Operation
- FET tuning range UHF through 1800 MHz
- 530 W Typical Output Power
- 16 dB Power Gain
- 68% Typical Drain Efficiency
- <0.3 dB Pulsed Amplitude Droop
- Internally pre-matched on input, unmatched output

Large Signal Models Available for ADS and MWO

Absolute Maximum Ratings (not simultaneous)

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V_{DSS}	125	Volts	25°C
Gate-to-Source Voltage	V_{GS}	-10, +2	Volts	25°C
Storage Temperature	T_{STG}	-65, +150	°C	
Operating Junction Temperature	T_J	225	°C	
Maximum Forward Gate Current	I_{GMAX}	84	mA	25°C
Maximum Drain Current ¹	I_{DMAX}	36	A	25°C
Soldering Temperature ²	T_s	245	°C	
Screw Torque	τ	40	in-oz	
CW Thermal Resistance, Junction to Case ³	$R_{\theta JC}$	0.47	°C/W	$P_{DISS} = 334 \text{ W}, 65^\circ\text{C}$
Pulsed Thermal Resistance, Junction to Case ³	$R_{\theta JC}$	0.28	°C/W	$P_{DISS} = 334 \text{ W}, 500 \mu\text{sec}, 10\%, 85^\circ\text{C}$
Pulsed Thermal Resistance, Junction to Case ⁴	$R_{\theta JC}$	0.31	°C/W	$P_{DISS} = 334 \text{ W}, 500 \mu\text{sec}, 10\%, 85^\circ\text{C}$
Case Operating Temperature ⁵	T_C	-40, +130	°C	$P_{DISS} = 334 \text{ W}, 500 \mu\text{sec}, 10\%$

Note:

¹ Current limit for long term, reliable operation

² Refer to the Application Note on soldering at <http://www.cree.com/rf/document-library>

³ Measured for the CGHV14500P

⁴ Measured for the CGHV14500F

⁵ See also, the Power Dissipation De-rating Curve on Page 5

Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics¹ ($T_C = 25^\circ\text{C}$)						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V_{DC}	$V_{DS} = 10 \text{ V}, I_D = 83.6 \text{ mA}$
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V_{DC}	$V_{DS} = 50 \text{ V}, I_D = 500 \text{ mA}$
Saturated Drain Current ²	I_{DS}	62.7	75.2	-	A	$V_{DS} = 6.0 \text{ V}, V_{GS} = 2.0 \text{ V}$
Drain-Source Breakdown Voltage	V_{BR}	150	-	-	V_{DC}	$V_{GS} = -8 \text{ V}, I_D = 83.6 \text{ mA}$
RF Characteristics³ ($T_C = 25^\circ\text{C}, F_0 = 1.3 \text{ GHz}$ unless otherwise noted)						
Output Power	P_{OUT}	422	530	-	W	$V_{DD} = 50 \text{ V}, I_{DQ} = 500 \text{ mA}, P_{IN} = 41 \text{ dBm}$
Drain Efficiency	D_E	63	68	-	%	$V_{DD} = 50 \text{ V}, I_{DQ} = 500 \text{ mA}, P_{IN} = 41 \text{ dBm}$
Power Gain	G_p	15.25	16.2	-	dB	$V_{DD} = 50 \text{ V}, I_{DQ} = 500 \text{ mA}, P_{IN} = 41 \text{ dBm}$
Pulsed Amplitude Droop	D	-	-0.3	-	dB	$V_{DD} = 50 \text{ V}, I_{DQ} = 500 \text{ mA}$
Output Mismatch Stress	VSWR	-	5 : 1	-	Ψ	No damage at all phase angles, $V_{DD} = 50 \text{ V}, I_{DQ} = 500 \text{ mA}, P_{IN} = 41 \text{ dBm Pulsed}$

Notes:

¹ Measured on wafer prior to packaging.

² Scaled from PCM data.

³ Measured in CGHV14500-AMP. Pulse Width = 500 μs , Duty Cycle = 10%.

Typical Performance

Figure 1. - CGHV14500 Typical Sparameters
 $V_{DD} = 50\text{ V}, I_{DQ} = 500\text{ mA}$

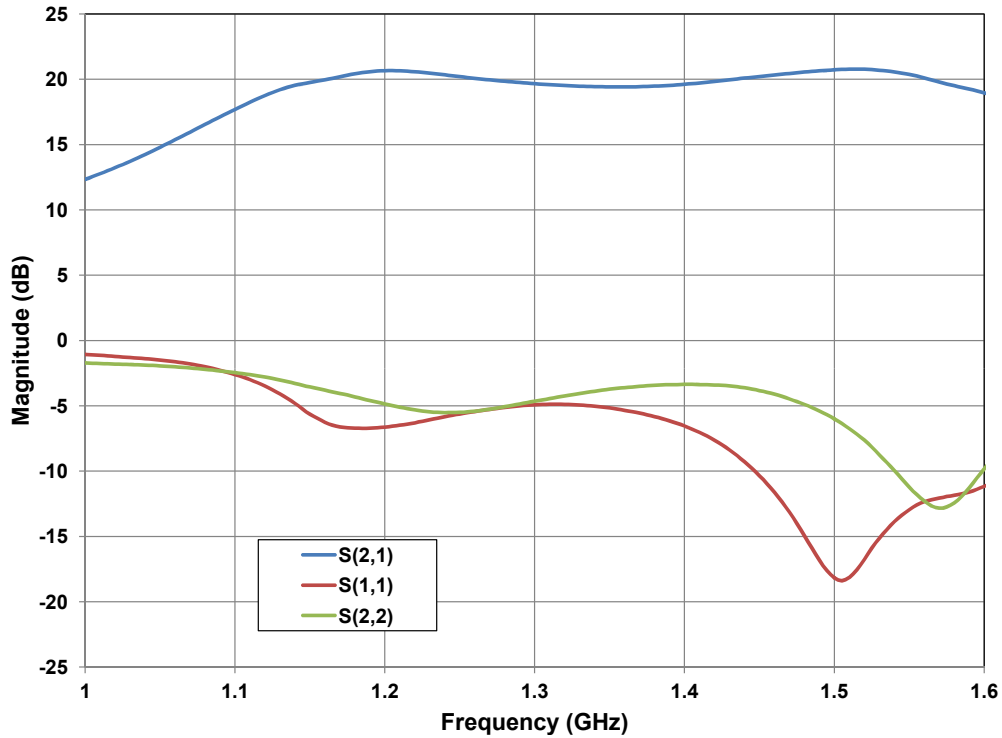
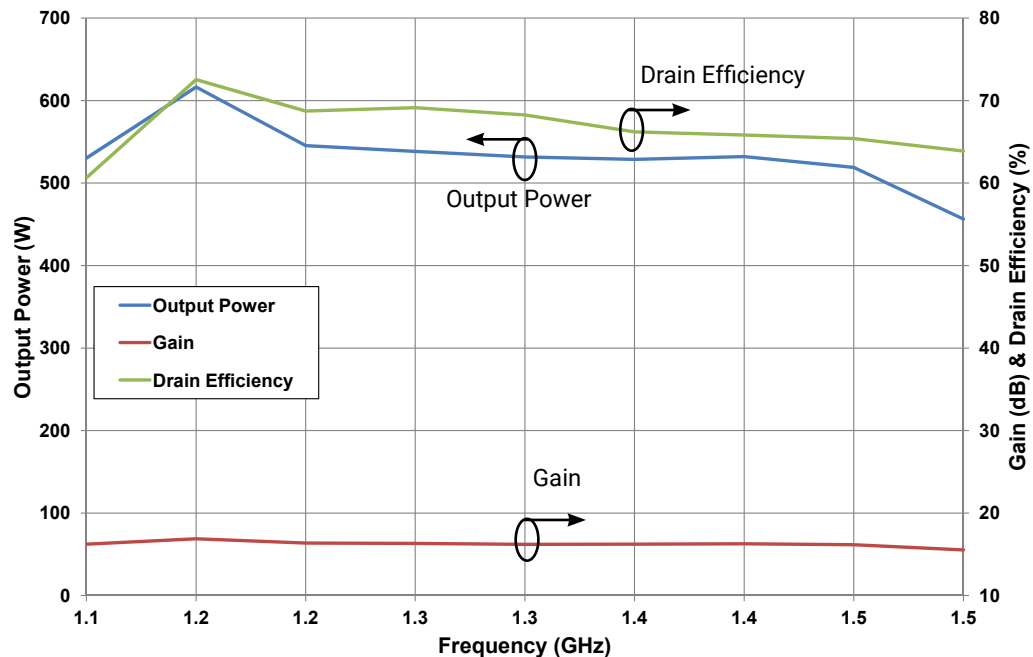


Figure 2. - CGHV14500 Typical RF Results
 $V_{DD} = 50\text{ V}, I_{DQ} = 500\text{ mA}, P_{IN} = 41\text{ dBm}$
 $T_{case} = 25^\circ\text{C}, \text{Pulse Width} = 500\ \mu\text{s}, \text{Duty Cycle} = 10\%$



Typical Performance

Figure 3. - CGHV14500 Typical RF Results

$V_{DD} = 50\text{ V}$, $I_{DQ} = 500\text{ mA}$, $P_{IN} = 41\text{ dBm}$
 $T_{case} = 85^\circ\text{C}$, Pulse Width = $500\ \mu\text{s}$, Duty Cycle = 10 %

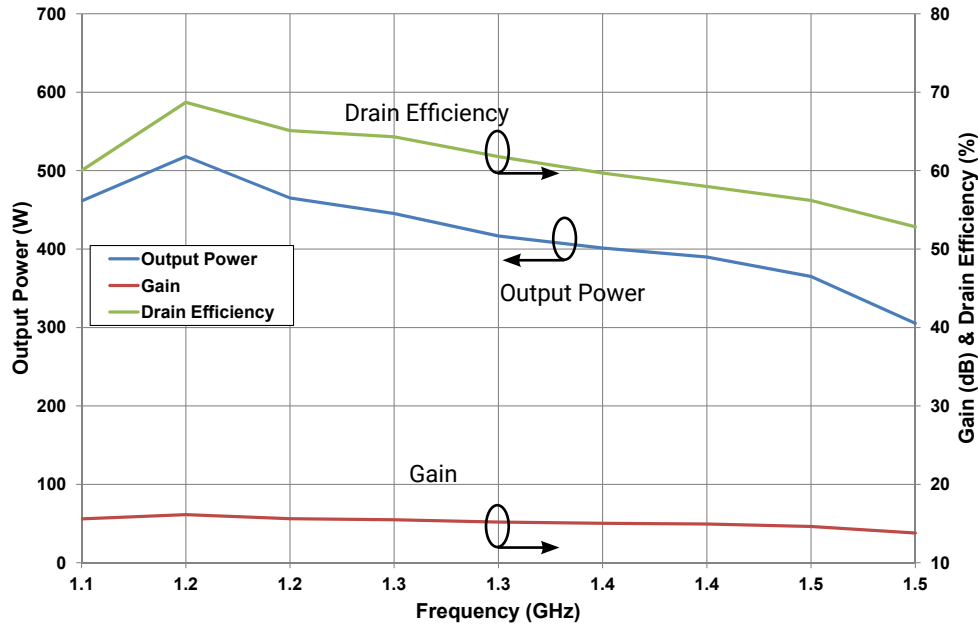
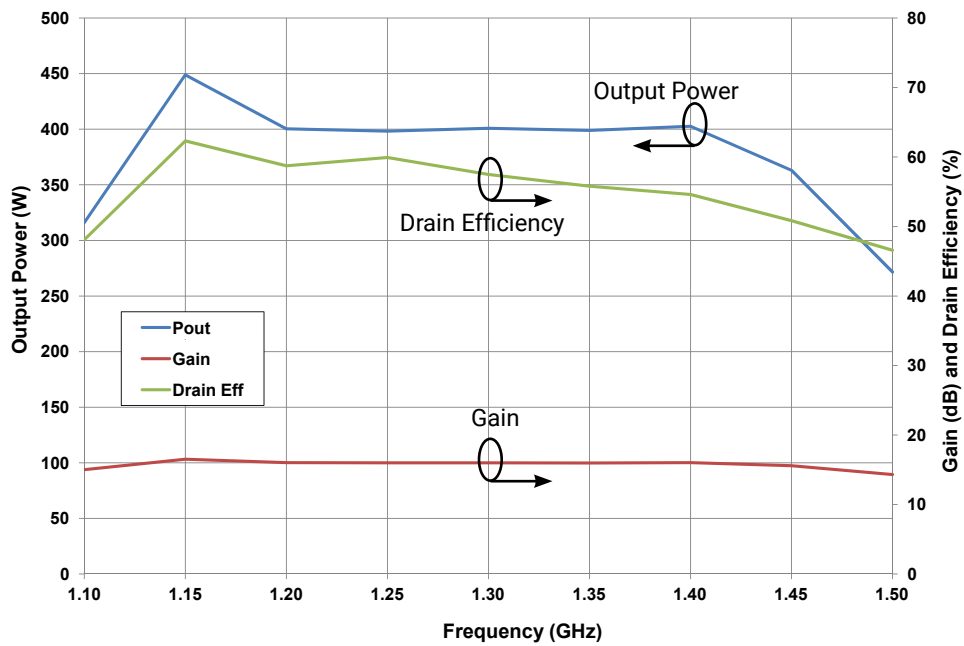
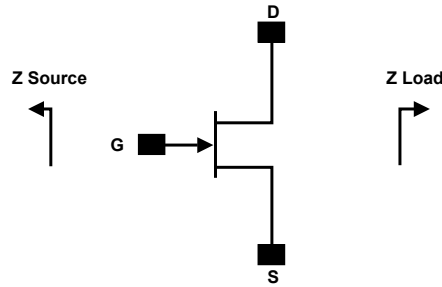


Figure 4. - CGHV14500 Typical CW RF Results

$V_{DD} = 50\text{ V}$, $I_{DQ} = 500\text{ mA}$, $P_{IN} = 40\text{ dBm}$, $T_{case} = 50^\circ\text{C}$



Source and Load Impedances



Frequency (MHz)	Z Source	Z Load
900	0.3 - j0.3	2.1 + j1.4
1000	0.3 - j0.4	2.0 + j0.7
1100	0.6 - j0.4	1.8 + j0.9
1200	0.8 - j0.7	1.5 + j0.9
1300	1.1 - j0.7	1.3 + j0.7
1400	1.2 - j0.1	1.2 + j0.5
1500	1.8 - j0.1	1.1 + j0.4

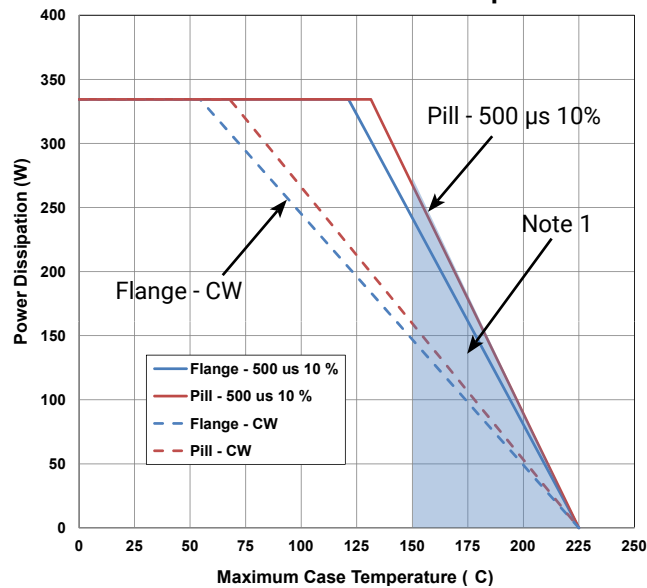
Note 1. $V_{DD} = 50\text{ V}$, $I_{DQ} = 500\text{ mA}$ in the 440117 package

Note 2. Optimized for power gain, P_{SAT} and Drain Efficiency

Note 3. When using this device at low frequency, series resistors should be used to maintain amplifier stability

CGHV14500 Power Dissipation De-rating Curve

Figure 5. - CGHV14500 Transient Power Dissipation De-Rating Curve

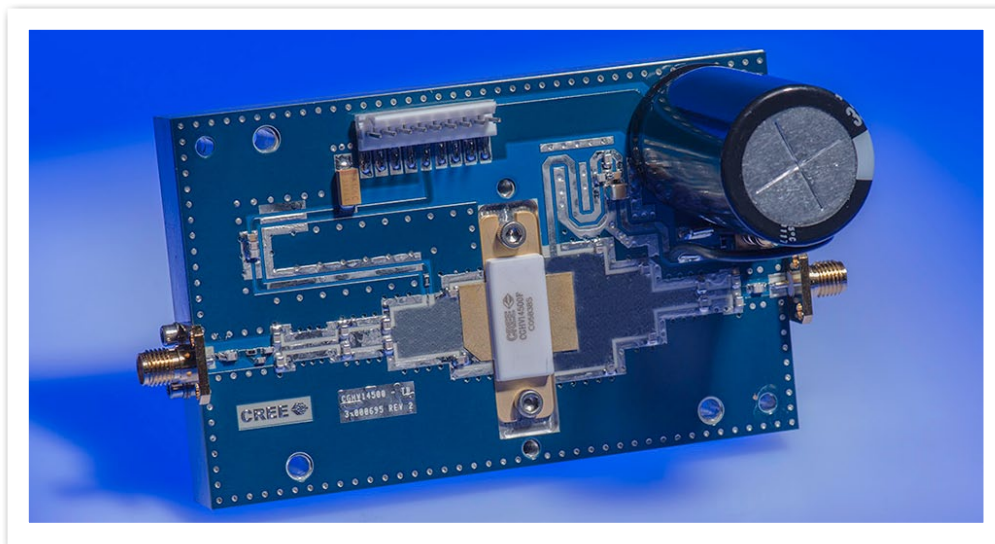


Note 1. Area exceeds Maximum Case Temperature (See Page 2).

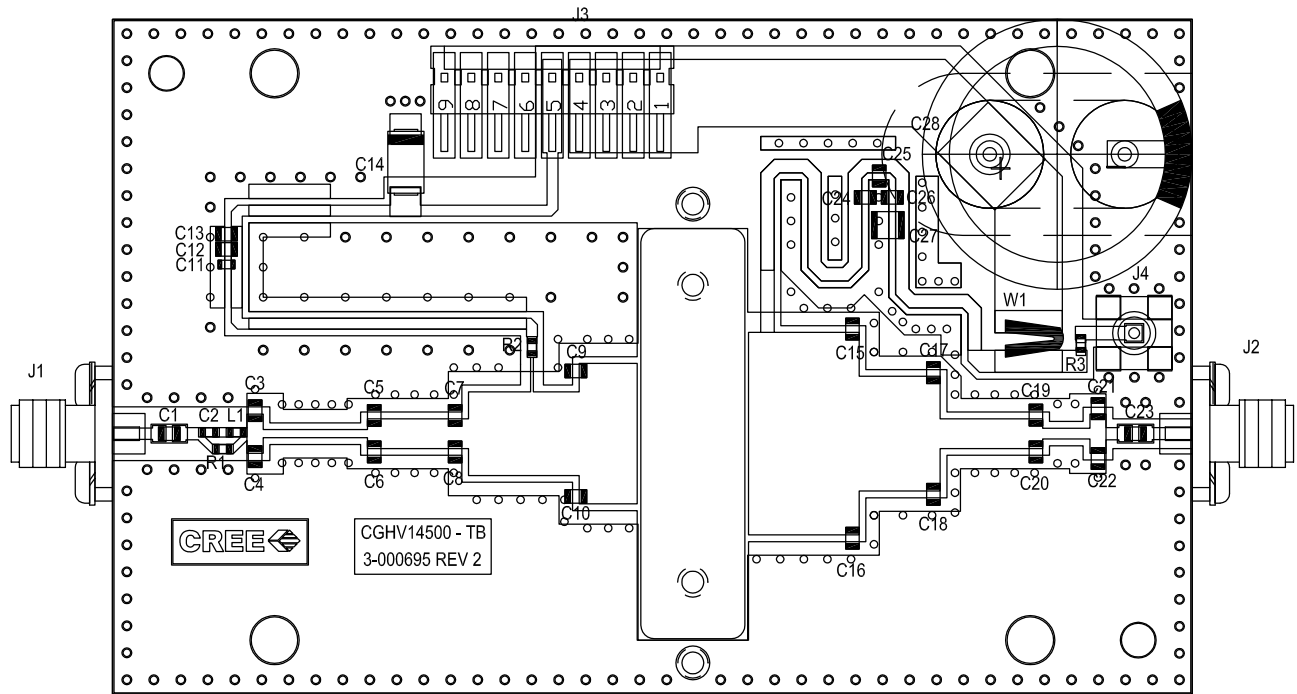
CGHV14500-AMP Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
R1	RES, 1/16W, 0603, 1%, 562 OHMS	1
R2	RES, 5.1 OHM, +/-1%, 1/16W, 0603	1
R3	RES, 1/16W, 0603, 1%, 4700 OHMS	1
L1	INDUCTOR, CHIP, 6.8 nH, 0603 SMT	1
C1, C23	CAP, 27pF, +/- 5%, 250V, 0805, ATC 600F	2
C2	CAP, 2.0pF, +/- 0.1pF, 0603, ATC	1
C3, C4	CAP, 1.5pF, +/-0.05pF, 250V, 0805, ATC 600F	2
C5,C6	CAP, 1.8pF, +/-0.1pF, 250V, 0805, ATC 600F	2
C7,C8	CAP, 4.3pF, +/-0.1pF, 250V, 0805, ATC 600F	2
C9,C10	CAP, 7.5pF, +/-0.1pF, 250V, 0805, ATC 600F	2
C11,C24	CAP, 47pF,+/-5%, 250V, 0805, ATC 600F	2
C12,C25	CAP, 100pF, +/-5%, 250V, 0805, ATC 600F	2
C13,C26	CAP, 33000PF, 0805,100V, X7R	2
C14	CAP 10uF 16V TANTALUM	1
C15,C16	CAP, 5.6pF, +/-0.1pF, 250V, 0805, ATC 600F	2
C17,C18	CAP, 3.6pF, +/-0.1pF, 250V, 0805, ATC 600F	2
C19,C20	CAP, 2.0pF, +/-0.1pF, 250V, 0805, ATC 600F	2
C21,C22	CAP, 0.7pF, +/-0.05pF, 0805, ATC 600F	2
C27	CAP, 1.0UF, 100V, 10%, X7R, 1210	1
C28	CAP, 3300 UF, +/-20%, 100V, ELECTROLYTIC	1
J1,J2	CONN, SMA, PANEL MOUNT JACK, FL	2
J3	HEADER RT>PLZ .1CEN LK 9POS	1
J4	CONNECTOR ; SMB, Straight, JACK,SMD	1
W1	CABLE ,18 AWG, 4.2	1
	PCB, RO4350B, 0.020' MIL THK, CGHV14500, 1.2-1.4GHZ	1
Q1	CGHV14500	1

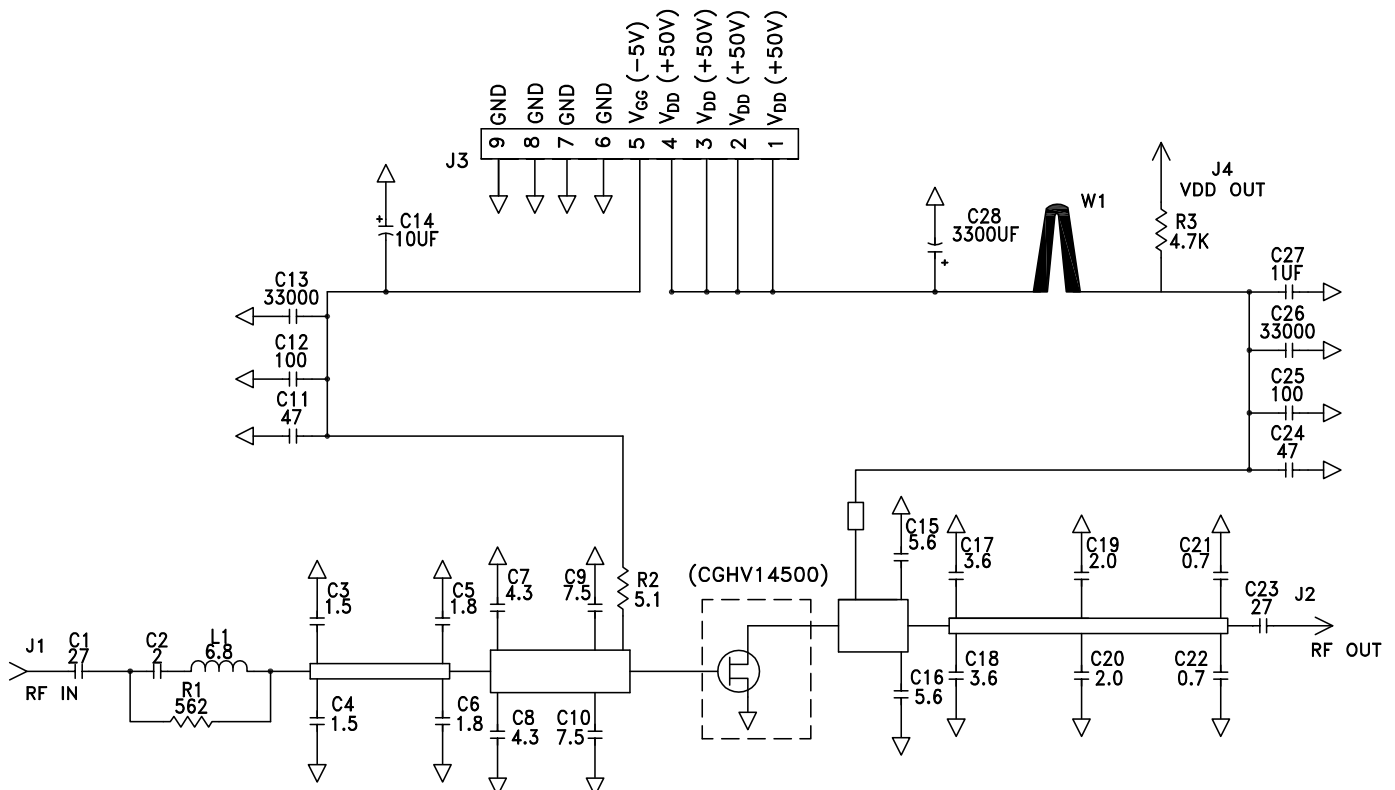
CGHV14500-AMP Demonstration Amplifier Circuit



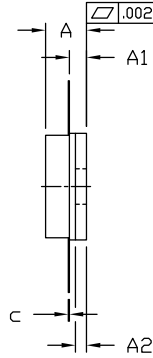
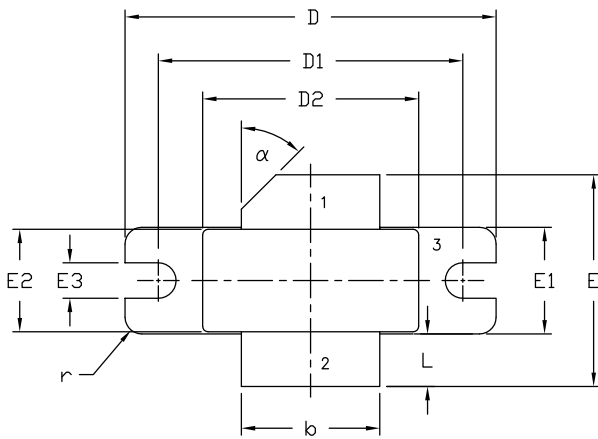
CGHV14500-AMP Demonstration Amplifier Circuit Outline



CGHV14500-AMP Demonstration Amplifier Circuit Schematic



Product Dimensions CGHV14500F (Package Type – 440117)



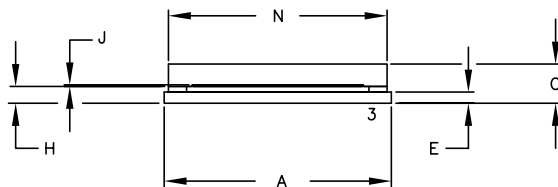
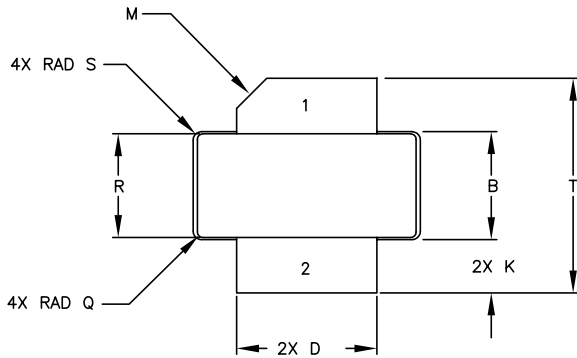
PIN 1. GATE
2. DRAIN
3. SOURCE

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M - 1994.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

DIM	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.138	0.158	3.51	4.01	
A1	0.057	0.067	1.45	1.70	
A2	0.035	0.045	0.89	1.14	
b	0.495	0.505	12.57	12.83	2x
c	0.003	0.006	0.08	0.15	
D	1.335	1.345	33.91	34.16	
D1	1.095	1.105	27.81	28.07	
D2	0.773	0.787	19.63	20.00	
E	0.745	0.785	18.92	19.94	
E1	0.380	0.390	9.65	9.91	
E2	0.365	0.375	9.72	9.53	
E3	0.123	0.133	3.12	3.38	
L	0.170	0.210	4.32	5.33	2x
r	0.06 TYP		0.06 TYP		4x
alpha	45° REF		45° REF		

Product Dimensions CGHV14500P (Package Type – 440133)



NOTES:

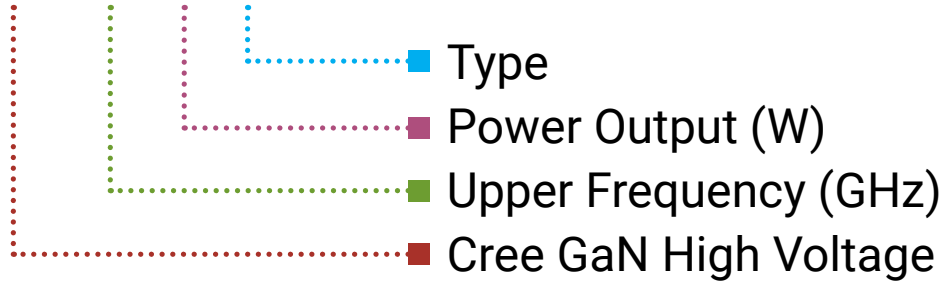
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.805	0.815	20.45	20.70
B	0.380	0.390	9.65	9.91
C	0.135	0.149	3.43	3.78
D	0.495	0.505	12.57	12.83
E	0.035	0.045	.89	1.14
H	0.057	0.067	1.45	1.70
J	0.003	0.006	.08	.15
K	0.170	0.210	4.32	5.33
M	45° REF		45° REF	
N	0.773	0.787	19.63	19.99
Q	0.020 REF		0.51 REF	
R	0.364	0.374	9.25	9.50
S	0.030 REF		0.76 REF	
T	0.745	0.785	18.92	19.94

STYLE 1:

PIN 1. GATE
2. DRAIN
3. SOURCE

CGHV14500F



Parameter	Value	Units
Upper Frequency ¹	1.4	GHz
Power Output	500	W
Type	F = Flanged P = Package	-

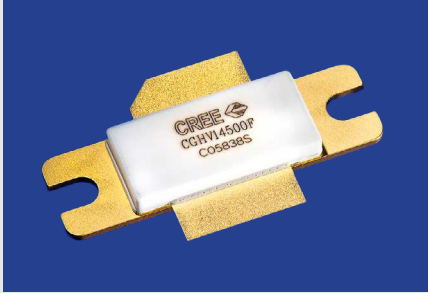

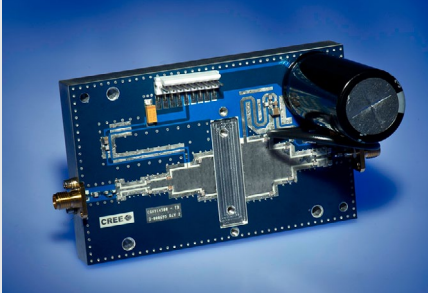
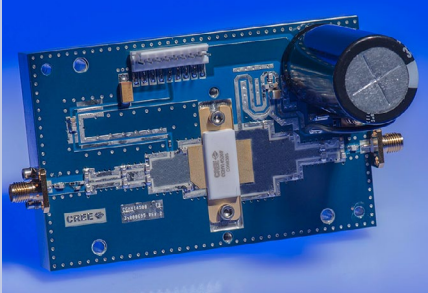
Table 1.

Note¹: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGHV14500F	GaN HEMT	Each	
CGHV14500P	GaN HEMT	Each	
CGHV14500F-TB	Test board without GaN HEMT	Each	
CGHV14500F-AMP	Test board with GaN HEMT installed	Each	



Disclaimer

Specifications are subject to change without notice. Cree, Inc. believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Cree for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Cree. Cree makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Cree in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Cree products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Cree product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility.

For more information, please contact:

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
www.cree.com/rf

Sarah Miller
Marketing
Cree, RF Components
1.919.407.5302

Ryan Baker
Marketing & Sales
Cree, RF Components
1.919.407.7816

Tom Dekker
Sales Director
Cree, RF Components
1.919.407.5639